

Solutions HW #7

ECE 606

Fall 2012

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$$\underline{\text{Q1}} \quad I_o = A q n_i^2 \left[ \frac{D_p}{N_D w_n} + \frac{D_n}{N_A w_p} \right]$$

In a  $p^n$  diode.  $N_A \gg N_D$

$$\therefore I_o = A q n_i^2 \left[ \frac{D_p}{N_D w_n} \right] \text{ (approx.)} \quad \rightarrow \textcircled{1}$$

Also  $D_p = \mu_p kT/q$

$$\text{At } 300\text{ K, } D_p = 0.026 \times 358 \text{ cm}^2/\text{s} = 9.1 \text{ cm}^2/\text{s.}$$

$$n_i = 1.5 \times 10^{10} \text{ cm}^{-3}$$

$$\therefore I_o = 1.638 \times 10^{-14} \text{ A} \quad (\text{using eq 1})$$

$$\text{At } 400\text{ K} \Rightarrow D_p = 12.25 \text{ cm}^2/\text{s.}, \quad n_i = 5.185 \times 10^{12} \text{ cm}^{-3}$$

$$[\because n_i \propto T^{3/2} \times \exp(-E_g/2kT)]$$

$$\therefore I_o = 2.635 \times 10^{-9} \text{ A}$$

Saturation current increases by five orders when the rise in temperature is 100°C.

(Q2)

### 6.10

(a) [Reverse biased] — there is a deficit of minority carrier in the quasineutral region immediately adjacent to the depletion region.

(b) Low-level injection DOES prevail. As required for low-level injection

$$|\Delta n_{p\max}| \equiv n_{p0} \ll p_p \quad \dots \text{for } x \leq -x_p$$

$$|\Delta p_{n\max}| \equiv p_{n0} \ll n_n \quad \dots \text{for } x \geq x_n$$

(c) Since we have low level injection,

$$N_A \approx p_{p0} \approx p_p = 10^{14}/\text{cm}^3$$

$$N_D \approx n_{n0} \approx n_n = 10^{15}/\text{cm}^3$$

(d) Invoking the law of the junction,

$$n(-x_p)p(-x_p) = n_i^2 e^{qV_A/kT}$$

or

$$V_A = \frac{kT}{q} \ln \left[ \frac{n(-x_p)p(-x_p)}{n_i^2} \right]$$

As deduced from Fig. P6.10,

$$n(-x_p) = 10^3/\text{cm}^3$$

$$p(-x_p) = 10^{14}/\text{cm}^3$$

and

$$n_i = \sqrt{n(\infty)p(\infty)} = \sqrt{n(-\infty)p(-\infty)} = \sqrt{10^{20}} = 10^{10}/\text{cm}^3$$

The foregoing manipulation to obtain  $n_i$  was necessary because the semiconductor used in fabricating the diode was not specified in the problem statement. Lastly, substituting into the  $V_A$  expression gives

$$V_A = (0.0259) \ln \left[ \frac{(10^3)(10^{14})}{10^{20}} \right] = -0.18\text{V}$$

Q3 Under reverse bias  $V_R = 1V$ .

$$\phi_j = V_T \ln \left[ \frac{N_A N_D}{n_i^2} \right] = 0.89V$$

$$\epsilon_s = \epsilon_{r(\text{silicon})} * \epsilon_0 = 11.68 \times 8.85 \times 10^{-14} \text{ F/cm} = 1.03 \times 10^{-12} \text{ F/cm}$$

$$W_{d0} = \sqrt{\frac{2\epsilon_s}{q}} \left( \frac{1}{N_A} + \frac{1}{N_D} \right) \phi_j = 15.4 \mu\text{m}$$

$$Q_{\text{def}} = q \frac{N_A N_D}{N_A + N_D} w_d A$$

$$= q \frac{N_A N_D}{N_A + N_D} A w_{d0} \sqrt{1 + \frac{V_R}{\phi_j}}$$

$$\Rightarrow Q_{\text{def}} = 3.5 \times 10^{-22} \text{ C}$$

Injection (Diffusion charge)

$$Q_D(V_D) = q A n_i^2 \left[ \frac{w_p^l}{2N_A} + \frac{L_p}{N_D} \right] \left( e^{qV_D/kT} - 1 \right)$$

$$Q_D(-1V) = 2.13 \times 10^{-53} \text{ C}$$

A4 This is one-dimensional Gauss Theorem

Let us begin by integrating Poisson eqn. from

$-T_p$  to  $T_n$ .

$$\int_{-T_p}^{T_n} \rho(x) dx = \int_{-x_p}^{-x_p} \rho(x) dx + \int_{-x_p}^{x_n} \rho(x) dx + \int_{x_n}^{T_n} \rho(x) dx$$

In the region  $-T_p < x < -x_p$  and  $x_n < x < T_n$   
the charge density is zero.

The only integral that remains is

$$\int_{-x_p}^{x_n} \rho(x) dx = \int_{-x_p}^{x_n} \epsilon_s \frac{dE}{dx} dx = \int_{-x_p}^{x_n} \epsilon_s dE$$

$$= E(x_n) - E(-x_p) = 0 - 0$$

Total charge enclosed within space-charge layer is zero.

$$\underline{\text{Q5}} \quad E_I - E_f = kT \ln \frac{P_p}{n_i}$$

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Intrinsic      Fermi-level

Inserting values  $E_I - E_f = 470.74 \text{ meV}$ .

Q6 For two materials, say material 1 and 2 having band-gap energies  $E_{g1}$  and  $E_{g2}$ , the ratio of their intrinsic carrier concentration is given by

$$\frac{n_{i1}}{n_{i2}} = \frac{\sqrt{N_C N_V} \exp[-E_{g1}/2kT]}{\sqrt{N_C N_V} \exp[-E_{g2}/2kT]}$$

$$= \sqrt{\frac{N_C N_V}{N_C N_V}} \exp\left[\frac{E_{g2} - E_{g1}}{2kT}\right]$$

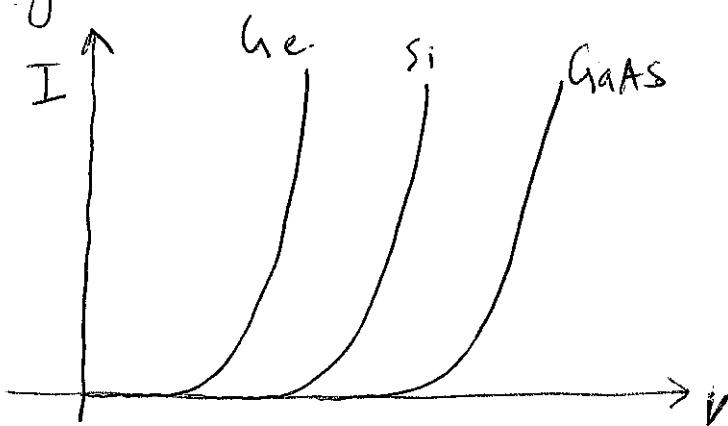
Assuming differences in values of  $N_C$  and  $N_V$  are small  $\Rightarrow \frac{n_{i1}}{n_{i2}} = \exp\left[\frac{E_{g2} - E_{g1}}{kT}\right]$

Considering the band gap of the three materials:

$$\frac{n_i^2 \text{ Ge}}{n_i^2 \text{ Si}} \approx \exp \left[ \frac{1.12 - 0.66}{0.026} \right] = 4.83 \times 10^{17}$$

Similarly,  $\frac{n_i^2 \text{ Si}}{n_i^2 \text{ GaAs}} = 1.03 \times 10^5$

Since the other terms in expression for  $I_o$  have much smaller dependence on the material, we can say that  $(I_o)_{\text{Ge}} \gg (I_o)_{\text{Si}} > (I_o)_{\text{GaAs}}$



Close

1. Print the shipping label and the packing slip.
2. Cut out the shipping label and the packing slip.
3. Securely pack the items in a UPS Shipping Pouch. If you do not have a pouch, affix the packing slip in the package.
4. Place the shipping label in a UPS Shipping Pouch. If you do not have a pouch, affix the label to your package using clear plastic shipping tape over the entire label. Take care not to cover any seams or closures on the package.
5. Take this package to a UPS location and mail it by January 28, 2012. To find your closest UPS location, visit the UPS Drop Off Locator or go to [www.ups.com](http://www.ups.com) and select "Drop Off".